

RoHS COMPLIANT

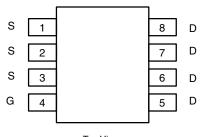
HALOGEN

FREE

Vishay Siliconix

P-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
- 150	0.295 at V _{GS} = - 10 V	- 8.9 ^c	23.2 nC		
	0.315 at V _{GS} = - 6 V	- 8.6 ^c	23.2 110		
SO-8					



Top View

Ordering Information:

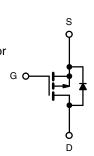
Si4455DY-T1-E3 (Lead (Pb)-free) Si4455DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- TrenchFET[®] Power MOSFET
- 100% R_q and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Active Clamp in Intermediate DC/ **DC** Power Supplies
- · H-Bridge High Side Switch for Lighting Application



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	- 150	v			
Gate-Source Voltage			± 20	v		
	T _C = 25 °C		- 2.8			
Continuous Drain Current (T ₁ = 150 °C)	T _C = 70 °C		- 2.3			
Continuous Drain Current $(1) = 150^{\circ}$ C)	T _A = 25 °C	I _D	- 2 ^{a, b}			
	T _A = 70 °C		- 1.6 ^{a, b}	A		
Pulsed Drain Current	I _{DM}	- 15	A			
Continuous Source Drain Diada Current	T _C = 25 °C	1	- 4.9			
Continuous Source-Drain Diode Current	T _A = 25 °C	۱ _S	- 2.5 ^{a, b}			
Avalanche Current	L = 0.1 mH	I _{AS}	- 15			
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	11.25	mJ		
	T _C = 25 °C		5.9			
Maximum Bawar Dissinction	T _C = 70 °C	P _D	3.8	w		
Maximum Power Dissipation	T _A = 25 °C	'D	3.1 ^{a, b}	vv		
	T _A = 70 °C	1	2 ^{a, b}			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C			

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Based on T_C = 25 °C.

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THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R _{thJA}	33	40	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	17	21	0/11	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. Maximum under steady state conditions is 80 °C/W.

For technical questions, contact: pmostechsupport@vishav.com

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 150			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 165			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i _D = - 250 μA		- 6.6		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 2		- 4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zaus Cata Malta na Dusia Cumunat	I _{DSS}	V _{DS} = - 150 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current		$V_{DS} = -150 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -5 V$, $V_{GS} = -10 V$	- 8			Α	
	D	V _{GS} = - 10 V, I _D = - 4 A		0.245	0.295	5 0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -6 V, I_D = -3 A$		0.260	0.315	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = 4 A		12		S	
Dynamic ^b				•	•	•	
Input Capacitance	C _{iss}			1190			
Output Capacitance	C _{oss}	V _{DS} = - 50 V, V _{GS} = 0 V, f = 1 MHz		61		pF	
Reverse Transfer Capacitance	C _{rss}			42			
Total Gate Charge	$Q_{g} \qquad \frac{V_{DS} = -75 \text{ V}, \text{ V}_{GS}}{}$	$V_{DS} = -75 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3 \text{ A}$		27.5	42		
				23.2	35		
Gate-Source Charge	Q _{gs}	V_{DS} = - 75 V, V_{GS} = - 6 V, I_{D} = - 3 A		5.4		nC	
Gate-Drain Charge	Q _{gd}			8.4			
Gate Resistance	R _g	f = 1 MHz		6.1	9.2	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = - 75 V, R_L = 25 Ω		95	145	1	
Turn-Off DelayTime	t _{d(off)}	${ m I_D}\cong$ - 3 A, ${ m V_{GEN}}$ = - 6 V, ${ m R_g}$ = 1 Ω		38	60		
Fall Time	t _f			34	51		
Turn-On Delay Time	t _{d(on)}			11	18	ns	
Rise Time	t _r	V_{DD} = - 75 V, R_L = 25 Ω		28	42]	
Turn-Off DelayTime	t _{d(off)}	${ m I}_{ m D}\cong$ - 3 A, ${ m V}_{ m GEN}$ = - 10 V, ${ m R}_{ m g}$ = 1 Ω		52	78		
Fall Time	t _f			35	53		
Drain-Source Body Diode Characterist	ics			•	•	•	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 13	•	
Pulse Diode Forward Current ^a	I _{SM}				- 15	A	
Body Diode Voltage	V _{SD}	I _S = - 3 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			65	90	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{} = 4 \wedge dl/dt = 100 \wedge luc = -25 \circ C$		180	270	nC	
Reverse Recovery Fall Time	t _a	$I_F = -4 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		45			
Reverse Recovery Rise Time	t _b			20		ns	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

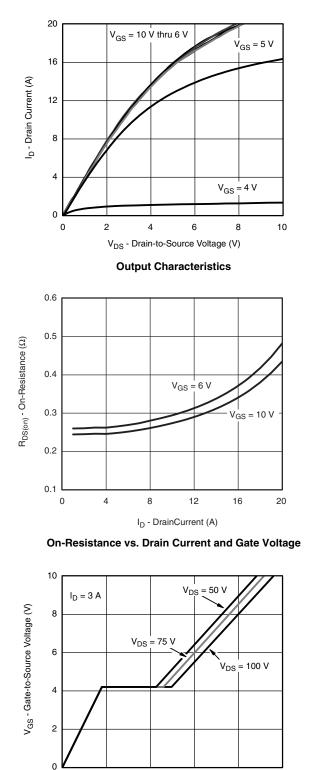
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

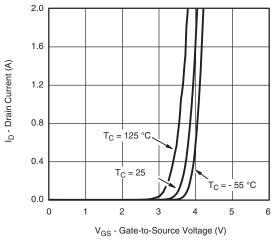
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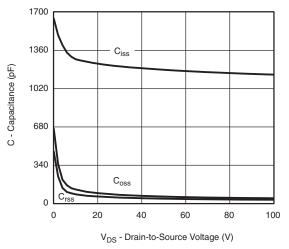
Si4455DY Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

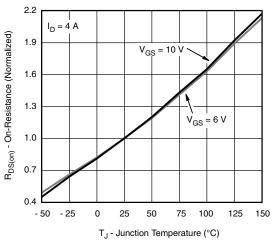




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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6

12

18

Q_q - TotalGateCharge(nC)

Gate Charge

24

30

0

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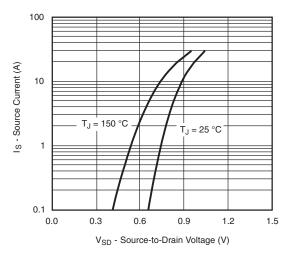
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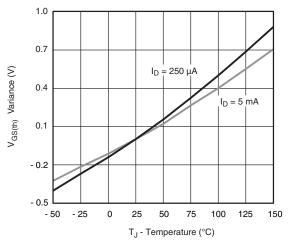
Vishay Siliconix



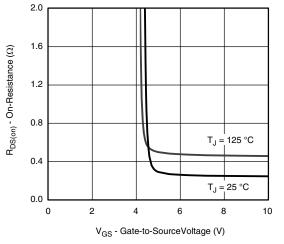
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



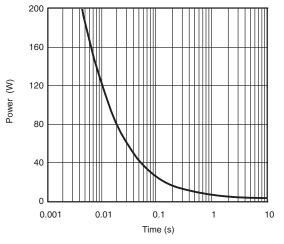




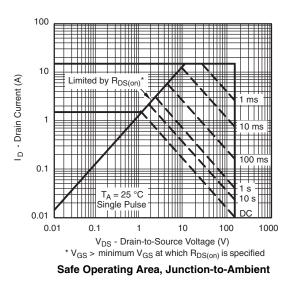
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



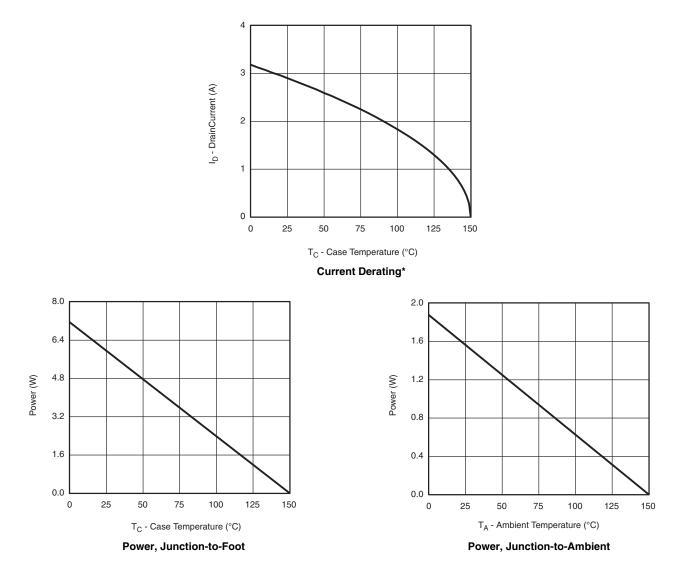
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



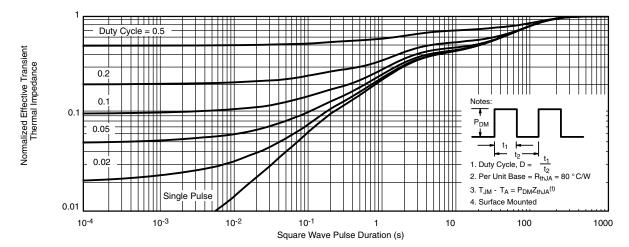
* The power dissipation P_D is based on $T_{J(max.)} = 150 \text{ °C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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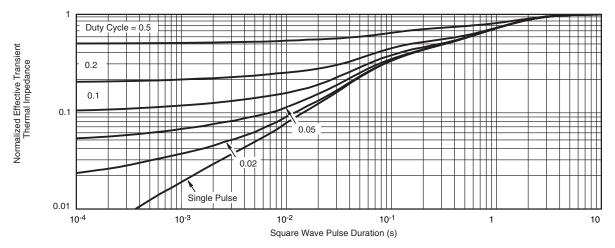


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?68631.

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Package Information

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES		
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 01-Jul-2024